

IN THE SPECIFICATION:

Please amend the specification as follows:

1. Page 1, please add the following:

- CROSS-REFERENCE TO RELATED APPLICATIONS

This application is a continuation application of prior application Ser. No. 09/127,050 filed July 31, 1998. -

2. Page 9, please replace the first full paragraph, lines 3-14, with the following:

3 Now referring to FIGURE 3B, there is shown a cross-sectional view cut along line
4 3B-3B of FIGURE 3A. The conductors 120a, 120b, 120c are formed in a insulating layer
5 200 (of an integrated circuit or printed circuit board, or the like). Additional layers of
6 substrate may be provided, such as a substrate layer 202. The conductors 120b and 120c are
7 each spaced apart substantially laterally from the conductor 120a, with the conductor 120b
8 positioned along one side of the conductor 120a and the conductor 120c positioned along the
9 other side of the conductor 120a. As will be appreciated, using present processes and
10 methods, the width of each of the conductors is generally about 0.7 microns and the spacing
11 therebetween is about 0.7 microns. However, the width and spacing dimensions may vary,
12 and elements/dimensions in the figure may vary and may not be drawn to scale. It is
13 expected that next generation processes will generate widths on the order of 0.2 to 0.4
14 microns, and perhaps even smaller.